IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yutaka TAKAGI et al.

Art Unit: 3652

Application No.: 10/809,679

Examiner: G. Lupino

Filing or 371(c) Date: March 26, 2004

Title: HANDLING DEVICE FOR

ELECTRONIC CHIP COMPONENTS AND HANDLING METHOD FOR ELECTRONIC CHIP COMPONENTS

INFORMATION DISCLOSURE STATEMENT COVER LETTER

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In accordance with 37 CFR § 1.56, Applicant submits references, including references cited in any included Official Communication issued in a corresponding non-U.S. application, with the attached Form PTO/SB/08a.

Where available, Applicant has provided:

- 1) English language equivalents of the foreign language references cited in the included Official Communication or Applicant's Specification and has not provided the foreign language references;
- 2) English language abstracts of the provided foreign language references obtained from a corresponding foreign Patent Office; and
- 3) English machine translations of the provided Japanese references that were prepared by the Intellectual Property Digital Library of the Japanese Patent Office.

Information Disclosure Statement Cover Letter November 15, 2007 Page 2 of 2

The statement is not a representation that all of the information cited is necessarily effective as prior art against the application.

Respectfully submitted,

Dated: November 15, 2007

/Christopher A. Bennett #46,710/ Attorneys for Applicant

KEATING & BENNETT, LLP

8180 Greensboro Drive, Suite 850 Tyson's Corner, VA 22102 Telephone: (703) 637-1480

Facsimile: (703) 637-1499

Joseph R. Keating Registration No. 37,368

Christopher A. Bennett Registration No. 46,710